The Future of Analog IC Technology

MPQ18021A

100V, 2.5A, High-Frequency Half-Bridge Gate Driver

DESCRIPTION

The MPQ18021A is a high-frequency, 100V, half-bridge, N-channel power MOSFET driver. Its low-side and high-side driver channels are independently controlled and matched with a time delay of less than 5ns. Under-voltage lockout on both high-side and low-side supplies force their outputs low in case of insufficient supply. The integrated bootstrap diode reduces external component count.

FEATURES

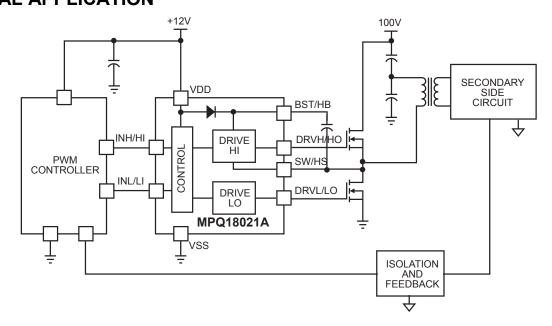
- Drives N-Channel MOSFET Half Bridge
- 115V V_{BST} Voltage Range
- On-Chip Bootstrap Diode
- Typical 16ns Propagation Delay Time
- Less Than 5ns Gate Drive Matching
- Drives 1nf Load with 12ns/9ns Rise/Fall Times with 12V VDD
- TTL Compatible Input
- Less Than 150μA Quiescent Current
- UVLO for Both High-Side and Low-Side
- In SOIC8 Package

APPLICATIONS

- Telecom Half-Bridge Power Supplies
- Avionics DC-DC Converters
- Two-Switch Forward Converters
- Active Clamp Forward Converters

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TYPICAL APPLICATION



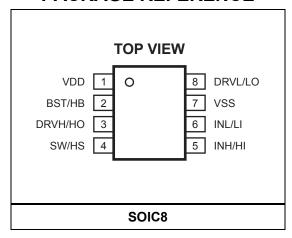


ORDERING INFORMATION

Part Number	Package	Top Marking
MPQ18021HS-A*	SOIC8	MP18021A

* For Tape & Reel, add suffix –Z (e.g. MPQ18021HS–A–Z); For RoHS compliant packaging, add suffix –LF (e.g. MPQ18021HS–A–LF–Z)

PACKAGE REFERENCE



ABSOLUTE MAXIMUM RATINGS (1)

Supply Voltage (VDD)0.3V to +20V
SW Voltage (V _{SW})5.0V to +105V
BST Voltage (V _{BST})0.3V to +120V
BST to SW0.3V to +18V
DRVH to SW0.3V to (BST-SW) + 0.3V
DRVL to VSS0.3V to (VDD + 0.3V)
All Other Pins0.3V to (VDD + 0.3V)
Continuous Power Dissipation $(T_A = 25^{\circ}C)^{(2)}$
SOIC81.4W
Junction Temperature150°C
Lead Temperature260°C
Storage Temperature65°C to +150°C

SW Voltage (V_{SW})......-1.0V to +100V SW slew rate<50V/ns Operating Junction Temp. (T_J). -40°C to +125°C

Thermal Resistance (4)	$oldsymbol{ heta}_{JA}$	$oldsymbol{ heta}_{JC}$	
SOIC8	90	45	.°C/W

Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T_J(MAX), the junction-to-ambient thermal resistance θ_{JA}, and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D(MAX)=(T_J(MAX)-T_A)/θ_{JA}. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.



ELECTRICAL CHARACTERISTICS

VDD = V_{BST} - V_{SW} =12V, VSS= V_{SW} = 0V, No load at DRVH and DRVL, T_J = -40°C to +125°C, Typical Value are T_J =25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Supply Currents						
VDD quiescent current	I_{DDQ}	INL=INH=0		100	150	μA
VDD operating current	I_{DDO}	f _{sw} =500kHz		2.8	3.5	mA
Floating driver quiescent current	I _{BSTQ}	INL=INH=0		60	90	μΑ
Floating driver operating current	I _{BSTO}	f _{sw} =500kHz		2.1	3	mA
Leakage Current	I_{LK}	BST=SW=100V		0.05	1	μА
Inputs						
INL/INH High				2	2.4	V
INL/INH Low			1	1.4		V
INL/INH internal pull-down	R _{IN}			185		kΩ
resistance	IXIN			100		KS 2
Under Voltage Protection						•
VDD rising threshold	V_{DDR}		7.4	8.1	8.9	V
VDD hysteresis	V_{DDH}			0.5		V
(BST-SW) rising threshold	V_{BSTR}		6.5	7.1	7.7	V
(BST-SW) hysteresis	V_{BSTH}			0.55		V
Bootstrap Diode						
Bootstrap diode VF @ 100uA	V_{F1}			0.5		V
Bootstrap diode VF @ 100mA	V_{F2}			0.9		V
Bootstrap diode dynamic R	R_D	@ 100mA		2.5		Ω
Low Side Gate Driver						
Low level output voltage	V _{OLL}	I _O =100mA		0.15	0.32	V
High level output voltage to rail	V_{OHL}	I _O =-100mA		0.45	1	V
Peak pull-up current	I _{OHL}	V _{DRVL} =0V, V _{DD} =12V		1.5		Α
reak pull-up culterit		V_{DRVL} =0V, V_{DD} =16V		2.5		Α
Poak pull down current	1	V _{DRVL} =V _{DD} =12V		2.5		Α
Peak pull-down current	I _{OLL}	V _{DRVL} =V _{DD} =16V		3.5		Α
Floating Gate Driver						
Low level output voltage	V_{OLH}	I _O =100mA		0.15	0.32	٧
High level output voltage to rail	V _{OHH}	I _O =-100mA		0.45	1	V
Peak pull-up current	I _{OHH}	V _{DRVH} =0V, V _{DD} =12V		1.5		Α
l ear pull-up cullellt		V _{DRVH} =0V, V _{DD} =16V		2.5		Α
Peak pull-down current	I _{OLH}	V _{DRVH} =V _{DD} =12V		2.5		Α
Gak pull-down current		V _{DRVH} =V _{DD} =16V		3.5		Α



ELECTRICAL CHARACTERISTICS (continued)

VDD = V_{BST} - V_{SW} =12V, VSS= V_{SW} = 0V, No load at DRVH and DRVL, T_J = -40°C to +125°C, Typical Value are T_J =25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Switching Spec Low Side Gate Driver						
Turn-off propagation delay INL falling to DRVL falling	T_{DLFF}			16		ns
Turn-on propagation delay INL rising to DRVL rising	T_{DLRR}			16		
DRVL rise time		C _L =1nF		12		ns
DRVL fall time		C _L =1nF		9		ns
Switching Spec Floating Gate	e Driver					
Turn-off propagation delay INL falling to DRVH falling	T_{DHFF}			16		ns
Turn-on propagation delay INL rising to DRVH rising				16		ns
DRVH rise time		C _L =1nF		12		ns
DRVH fall time		C _L =1nF		9		ns
Switching Spec Matching						
Floating driver turn-off to low side driver turn-on	T_{MON}			1	5	ns
Low side driver turn-off to floating driver turn-on	T_{MOFF}			1	5	ns
Minimum input pulse width that changes the output	T_PW				50 ⁽⁵⁾	ns
Bootstrap diode turn-on or turn-off time	T_{BS}			10 ⁽⁵⁾		ns

Note:

5) Guaranteed by design.

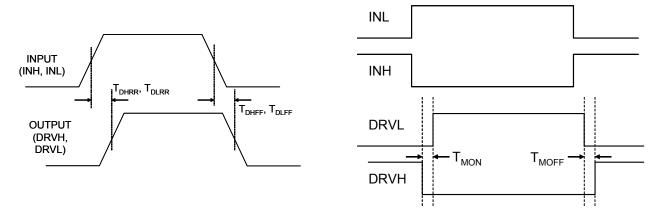


Figure 1: Timing Diagram



PIN FUNCTIONS

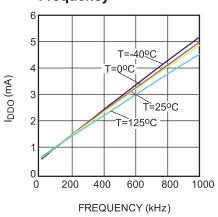
Pin#	Name	Description
1		Supply input. Supplies power to all the internal circuitry. Requires a decoupling capacitor to ground placed close to this pin to ensure stable and clean supply.
2	BST/HB	Bootstrap. Positive power supply for the internal floating high-side MOSFET driver. Connect a bypass capacitor between this pin and SW pin.
3	DRVH/HO	Floating driver output.
4	SW/HS	Switching node.
5	INH/HI	Control signal input for the floating driver.
6	INL/LI	Control signal input for the low side driver.
7	VSS	Chip ground.
8	DRVL/LO	Low side driver output.



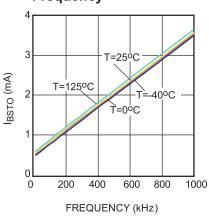
TYPICAL PERFORMANCE CHARACTERISTICS

VDD =12V, VSS=V_{SW} = 0V, T_A= 25°C, unless otherwise noted.

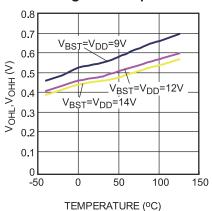
I_{DDO} Operation Current vs. Frequency



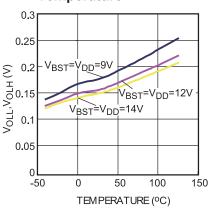
IBSTO Operation Current vs. Frequency



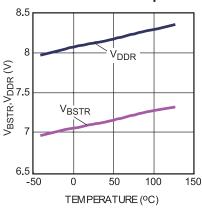
High Level Output Voltage vs. Temperature



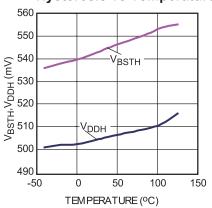
Low Level Output Voltage vs. Temperature



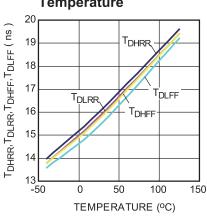
Undervoltage Lockout Threshold vs.Temperature



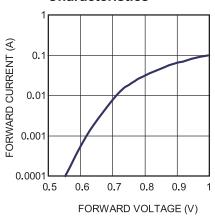
Undervoltage Lockout
Hysteresis vs.Temperature



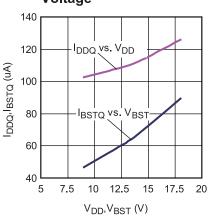
Propagation Delay vs. Temperature



Bootstrap Diode I-V Characteristics



Quiescent Current vs. Voltage

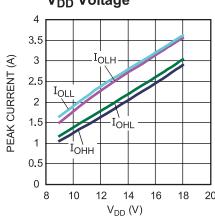




TYPICAL PERFORMANCE CHARACTERISTICS (continued)

VDD =12V, VSS= V_{SW} = 0V, T_A = 25°C, unless otherwise noted.

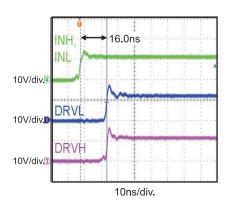


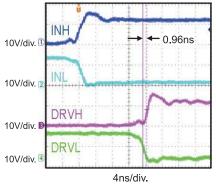


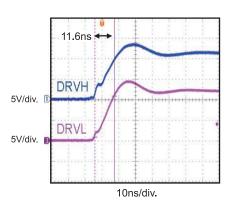
Turn-on Propagation Delay

Gate Drive Matching TMOFF

Drive Rise Time (1nF Load)



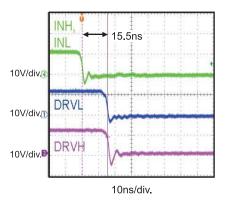


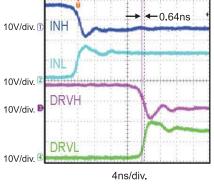


Turn-off Propagation Delay

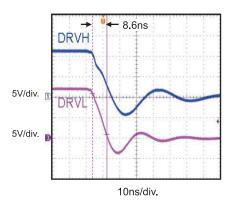
Gate Drive Matching TMON

Drive Fall Time (1nF Load)



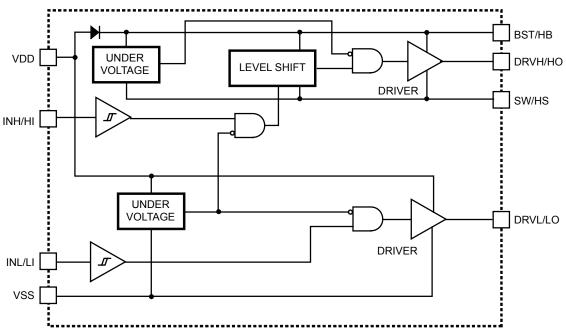


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BLOCK DIAGRAM





APPLICATION

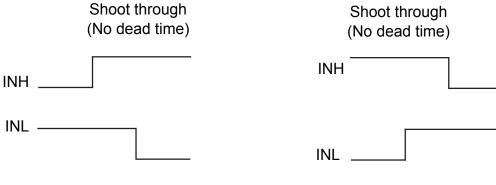
The INH and INL input signals can be controlled independently. If both INH and INL control the HSFET and LSFET of the same bridge, then users must avoid shoot through by a setting

high, and vice versa, as per **Figure 3** below. Dead time is defined as the time internal when both INH and INL are low.

Ot through

Shoot through

sufficient dead time between INH low and INL



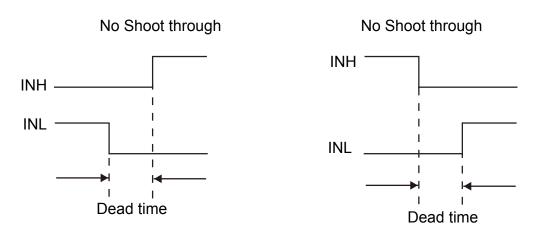


Figure 3: INH and INL Dead Time

Input Voltage



REFERENCE DESIGN CIRCUITS

Half-Bridge Converter

In half-bridge converter topology, the MOSFETs are alternately driven with some dead time between signals. Therefore, INH and INL are

driven with alternating signals from the PWM controller. The input voltage can go up to 100V in this application.

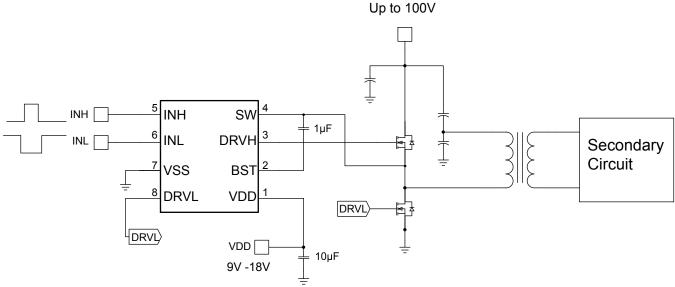


Figure 4: Half-Bridge Converter

Two-Switch Forward Converter

In two-switch forward converter topology, both MOSFETs turn on and off together. The input signals (INH and INL) come from the PWM controller, which senses the output voltage (and output current if current-mode control is used).

The Schottky diodes clamp the reverse swing of the power transformer and must be rated at the input voltage. The input voltage can go up to 100V in this circuit.

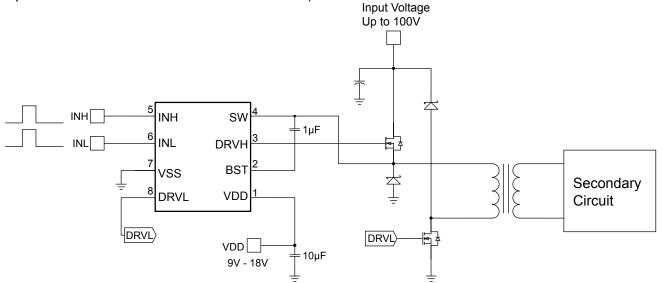


Figure 5: Two-Switch Forward Converter



Active-Clamp Forward Converter

In active-clamp forward converter topology, the MOSFETs are driven alternately. The high-side MOSFET and the capacitor C_{reset}, losslessly reset the power transformer.

This topology lends itself well to run at duty cycles exceeding 50%. Therefore, the input voltage for this application may not be able to go to 100V.

Input Voltage

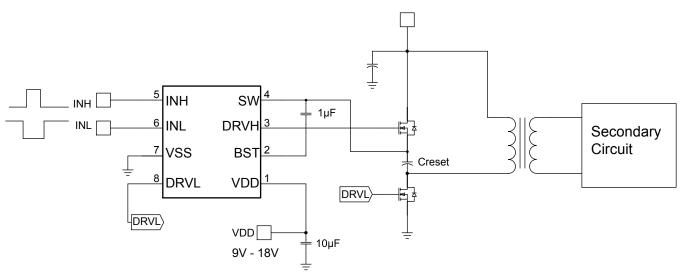
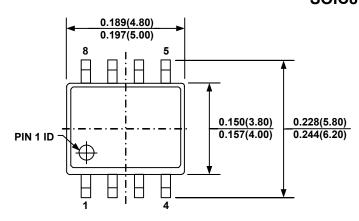


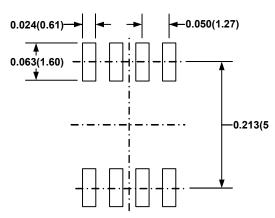
Figure 6: Active-Clamp Forward Converter



PACKAGE INFORMATION

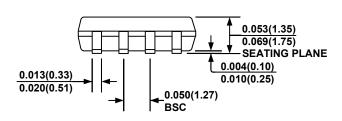
SOIC8



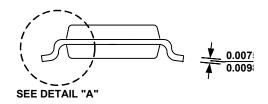


TOP VIEW

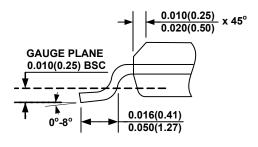
RECOMMENDED LAND PATTERN



FRONT VIEW



SIDE VIEW



DETAIL "A"

NOTE:

- 1) CONTROL DIMENSION IS IN INCHES. DIMENSION IN BRACKET IS IN MILLIMETERS.
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLAS PROTRUSIONS OR GATE BURRS.
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD I OR PROTRUSIONS.
- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FC SHALL BE 0.004" INCHES MAX.
- 5) DRAWING CONFORMS TO JEDEC MS-012, VARIATIO
- 6) DRAWING IS NOT TO SCALE.

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